MOSFET – N-Channel, SUPREMOS[®]

600 V, 47 A, 62 m Ω

FCH47N60N

Description

The SUPREMOS MOSFET is ON Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SUPREMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.

Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- $R_{DS(on)} = 51.5 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 23.5 \text{ A}$
- Ultra Low Gate Charge (Typ. Q_g = 115 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 511 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

Applications

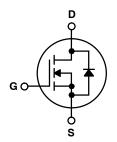
- Solar Inverter
- AC-DC Power Supply



ON Semiconductor®

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V _{DS}	R _{DS(ON)} MAX	I _D MAX		
600 V	62 mΩ @ 10 V	47 A		

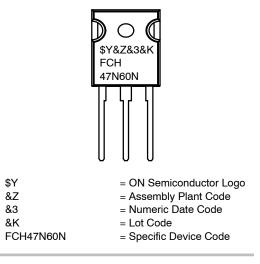


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

Symbol		Parameter		Unit
V _{DSS}	Drain to Source Voltage		600	V
V _{GSS}	Gate to Source Voltage		±30	V
I _D	Drain Current	– Continuous (T _C = 25°C)	47	А
		– Continuous (T _C = 100°C)	29.7	7
I _{DM}	Drain Current	– Pulsed (Note 1)	141	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		3068	mJ
I _{AR}	Avalanche Current (Note 1)		15.7	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		3.7	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P _D	Power Dissipation	(T _C = 25°C)	368	W
		– Derate above 25°C	2.94	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to + 150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Second		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. $I_{AS} = 15.7 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25 ^{\circ}C$ 3. $I_{SD} \le 47 \text{ A}$, di/dt $\le 200 \text{ A/}\mu$ s, $V_{DD} \le 380 \text{ V}$, starting $T_J = 25 ^{\circ}C$

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FCH47N60N	FCH47N60N	TO-247-3LD	Tube	N/A	N/A	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.34	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS	•	•	•		
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 25^{\circ}\text{C}$	600	-	_	V
$\Delta \text{BV}_{\text{DSS}}$ / $\Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C	-	0.78	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 480 V, V_{GS} = 0 V	-	-	10	μΑ
		V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125°C	-	-	100	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = +30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARA	CTERISTICS	-				-
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \text{ mA}$	2	-	4	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 23.5 A	-	51.5	62.0	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 23.5 \text{ A}$	-	56	_	S
OYNAMIC C	HARACTERISTICS	-	-	-		-
C _{iss}	Input Capacitance	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V},$	-	5037	6700	pF
C _{oss}	Output Capacitance	- f = 1 MHz	-	200	270	pF
C _{rss}	Reverse Transfer Capacitance		-	2.5	4.0	pF
C _{oss}	Output Capacitance	V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz	-	108	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 380 V, V_{GS} = 0 V	-	511	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 23.5 \text{ A},$	-	115	151	nC
Q _{gs}	Gate to Source Gate Charge	V _{GS} = 10 V (Note 4)	-	21	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	34	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1 MHz	-	0.9	-	Ω
SWITCHING	CHARACTERISTICS	-				-
t _{d(on)}	Turn-On Delay Time	V _{DD} = 380 V, I _D = 23.5 A,	-	11	32	ns
t _r	Turn–On Rise Time	$\begin{array}{c} R_{G} = 4.7 \ \Omega \\ (\text{Note 4}) \end{array}$	-	9	28	ns
t _{d(off)}	Turn-Off Delay Time		-	135	280	ns
t _f	Turn-Off Fall Time	1	-	22	54	ns
RAIN-SOU	RCE DIODE CHARACTERISTICS	•	-	- -		-
۱ _S	Maximum Continuous Drain to Source Diode Forward Current			-	47	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	141	Α
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 23.5 \text{ A}$	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 23.5 A,	-	495	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/ms	_	12	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially Independent of Operating Temperature Typical Characteristics.

TYPICAL CHARACTERISTICS

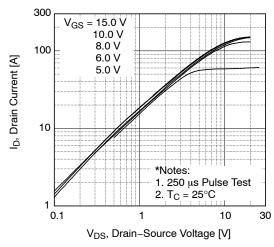


Figure 1. On-Region Characteristics

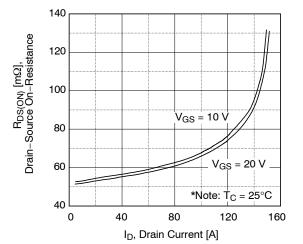


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

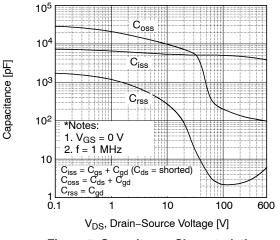
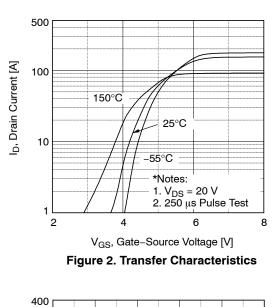


Figure 5. Capacitance Characteristics



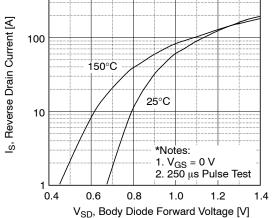
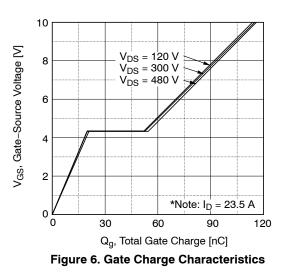


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL CHARACTERISTICS (continued)

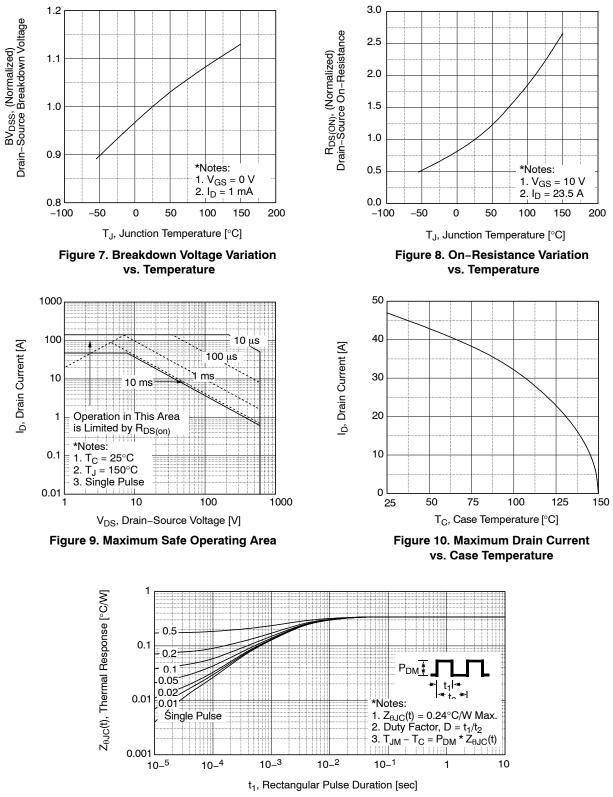


Figure 11. Transient Thermal Response Curve

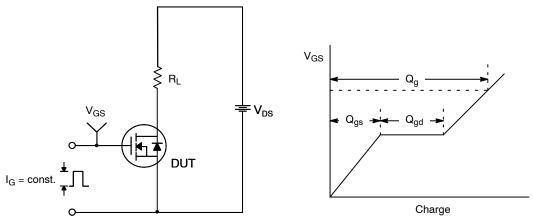


Figure 12. Gate Charge Test Circuit & Waveform

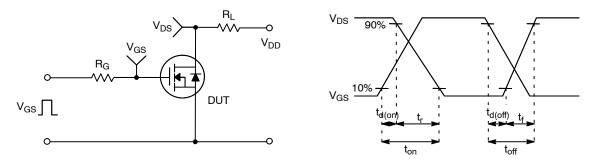
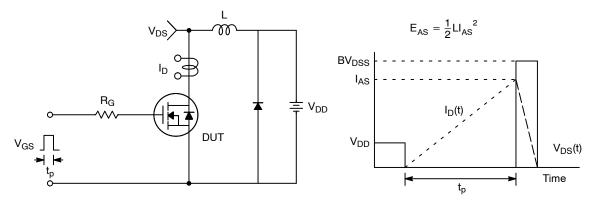


Figure 13. Resistive Switching Test Circuit & Waveforms





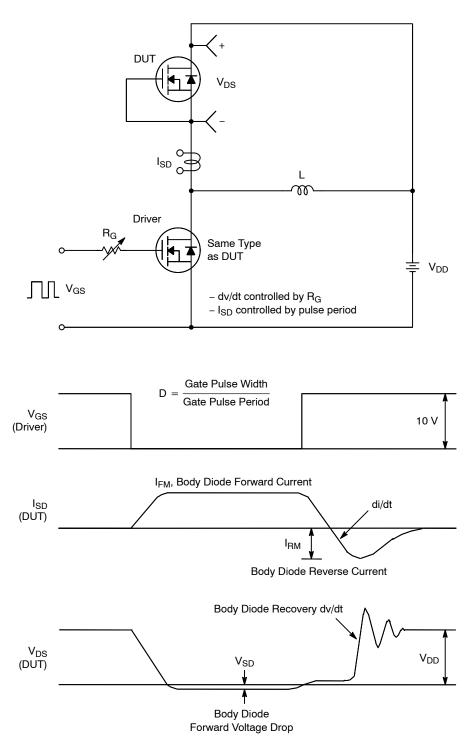
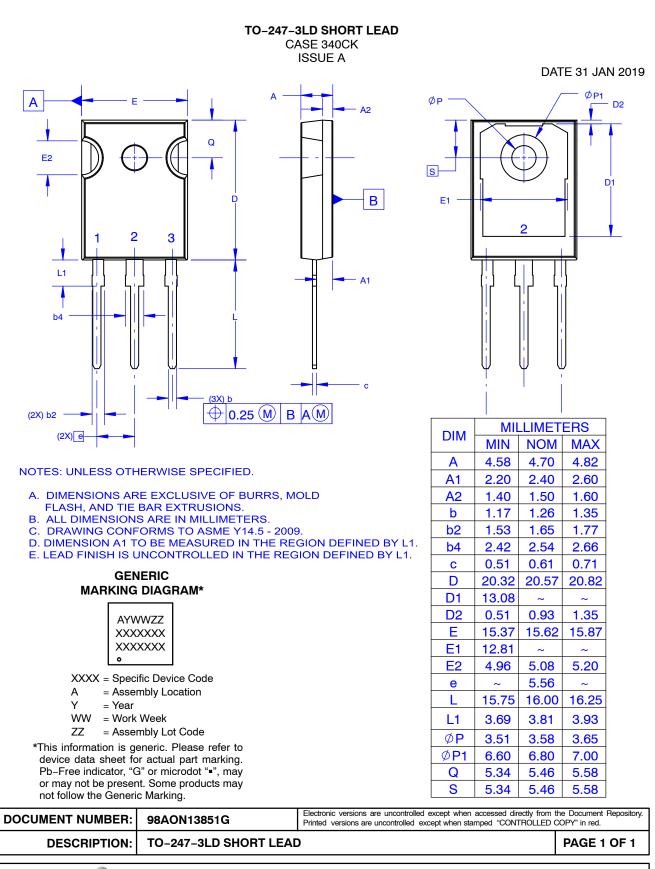


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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